



Ferrites and accessories

RM 6, RM 6 LP Core and accessories

Series/Type: B65807, B65808, B65821, B65659

Date: May 2017

The following products presented in this data sheet are being withdrawn.

| Ordering Code | Substitute Product | Date of Withdrawal | Deadline Last Orders | Last Shipments |
|-----------------|--------------------|--------------------|----------------------|----------------|
| B65808A5000X000 | | 2018-06-08 | 2018-09-14 | 2018-12-14 |

For further information please contact your nearest EPCOS sales office, which will also support you in selecting a suitable substitute. The addresses of our worldwide sales network are presented at www.epcos.com/sales.

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RM 6

Core and accessories

| Individual parts | Part no. | Page |
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| Adjusting screw | B65659 | 10 |
| Core | B65807 | 3 |
| Clamps | B65808 | 8 |
| Insulating washer 1 | B65808 | 8 |
| Coil former | B65808 | 5, 6, 7 |
| Core | B65807 | 3 |
| Threaded sleeve (glued-in) | | |
| Insulating washer 2 | B65808 | 8 |

FRM0048-K

Example of an assembly set

Also available:

| | | |
|------------------------------------|---------|----|
| Coil former for SMPS transf. | B65808 | 6 |
| Coil former for power applications | B65808 | 7 |
| SMD coil former | B65821 | 9 |
| Clamp | B65808 | 9 |
| <u>RM 6 low profile:</u> | | |
| Core | B65807P | 11 |

RM 6
Core
B65807

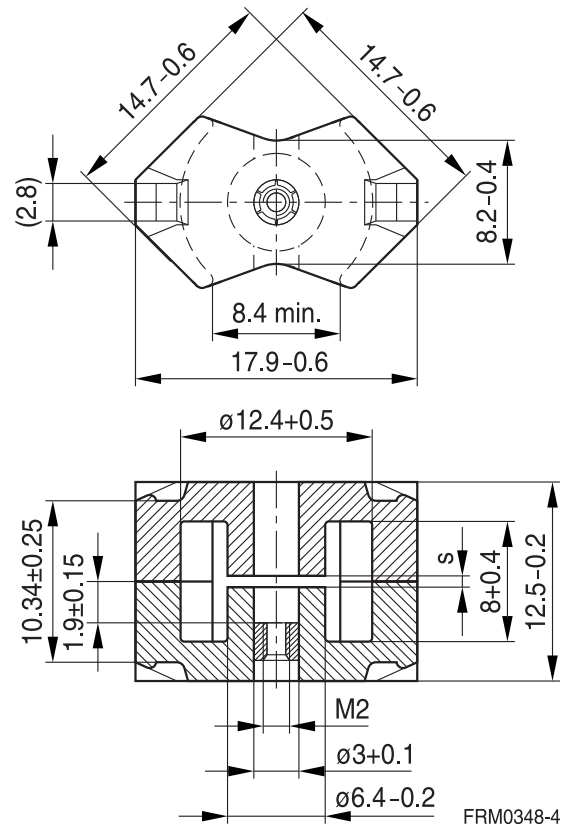
- To IEC 62317-4
- Core without center hole for transformer applications
- Delivery mode: sets

Magnetic characteristics (per set)

| | with center hole | without center hole | |
|--------------|------------------|---------------------|------------------|
| $\Sigma l/A$ | 0.86 | 0.78 | mm ⁻¹ |
| l_e | 26.9 | 28.6 | mm |
| A_e | 31.3 | 36.6 | mm ² |
| A_{min} | — | 31 | mm ² |
| V_e | 840 | 1050 | mm ³ |

Approx. weight (per set)

| m | 4.9 | 5.1 | g |
|---|-----|-----|---|
| | | | |



FRM0348-4

Gapped (A_L values/air gaps examples)

| Material | A_L value nH | s approx. mm | μ_e | Ordering code ¹⁾ -J without center hole -N with threaded sleeve -C with center hole |
|----------|-------------------|--------------------|---------|---|
| K1 | 40 ±3% | 0.80 | 27.4 | B65807+0040A001 |
| M33 | 63 ±3% | 0.60 | 43.2 | B65807+0063A033 |
| | 100 ±3% | 0.38 | 68.5 | B65807+0100A033 |
| N48 | 160 ±3% | 0.22 | 109 | B65807+0160A048 |
| | 250 ±3% | 0.12 | 171 | B65807+0250A048 |
| | 315 ±3% | 0.08 | 215 | B65807+0315A048 |
| | 400 ±3% | 0.05 | 274 | B65807+0400A048 |
| N41 | 250 ±3% | 0.17 | 155 | B65807J0250A041 |

1) Replace the + by the code letter "C" or "N" for the required version. Standard version is "C".

Ungapped

| Material | A _L value nH | μ _e | P _V W/set | Ordering code -C with center hole -J without center hole |
|----------|----------------------------|----------------|----------------------------------|--|
| N48 | 2200 +30/-20% | 1500 | | B65807C0000R048 |
| N45 | 3500 +30/-20% | 2180 | | B65807J0000R045 |
| N30 | 4300 +30/-20% | 2670 | | B65807J0000R030 |
| T35 | 6200 +30/-20% | 3860 | | B65807J0000R035 |
| T38 | 8600 +40/-30% | 5350 | | B65807J0000Y038 |
| T66 | 12300 +40/-30% | 7650 | | B65807J0000Y066 |
| N49 | 1700 +30/-20% | 1060 | < 0.15 (50 mT, 500 kHz, 100 °C) | B65807J0000R049 |
| N87 | 2400 +30/-20% | 1490 | < 0.51 (200 mT, 100 kHz, 100 °C) | B65807J0000R087 |
| N97 | 2400 +30/-20% | 1490 | < 0.39 (200 mT, 100 kHz, 100 °C) | B65807J0000R097 |
| N95 | 2800 +30/-20% | 1740 | < 0.45 (200 mT, 100 kHz, 100 °C) | B65807J0000R095 |
| N41 | 3100 +30/-20% | 1930 | < 0.16 (200 mT, 25 kHz, 100 °C) | B65807J0000R041 |

Other A_L values/air gaps and materials available on request — see Processing remarks on page 12.

Coil former, squared pins

Material: GFR thermosetting plastic (UL 94 V-0, insulation class to IEC 60085: F \triangleq max. operating temperature 155 °C), color code black
 Sumikon PM 9630® [E41429 (M)], SUMITOMO BAKELITE CO LTD

Solderability: to IEC 60068-2-20, test Ta, method 1 (aging 3): 235 °C, 2 s

Resistance to soldering heat: to IEC 60068-2-20, test Tb, method 1B: 350 °C, 3.5 s

Winding: see Processing notes, 2.1

For matching clamp and insulating washers see page 8.

| Sections | A_N mm ² | l_N mm | A_R value $\mu\Omega$ | Pins | Ordering code |
|----------|--------------------------|-------------|----------------------------|-------------|---|
| 1 | 15 | 30 | 69 | 4 5 6 | B65808N1004D001 B65808N1005D001 B65808N1006D001 |
| 2 | 14 | 30 | 73 | 4 6 | B65808N1004D002 B65808N1006D002 |



Coil former for SMPS transformers with line isolation

The creepage distances and clearances are designed such that the coil former is suitable for use in SMPS transformers with line isolation.

- Closed center flange with external wire guide
- Optimized for use with automatic winding machines

Material: GFR thermosetting plastic (UL 94 V-0, insulation class to IEC 60085:
 $F \triangleq$ max. operating temperature 155 °C), color code black
 Sumikon PM 9630® [E41429 (M)], SUMITOMO BAKELITE CO LTD

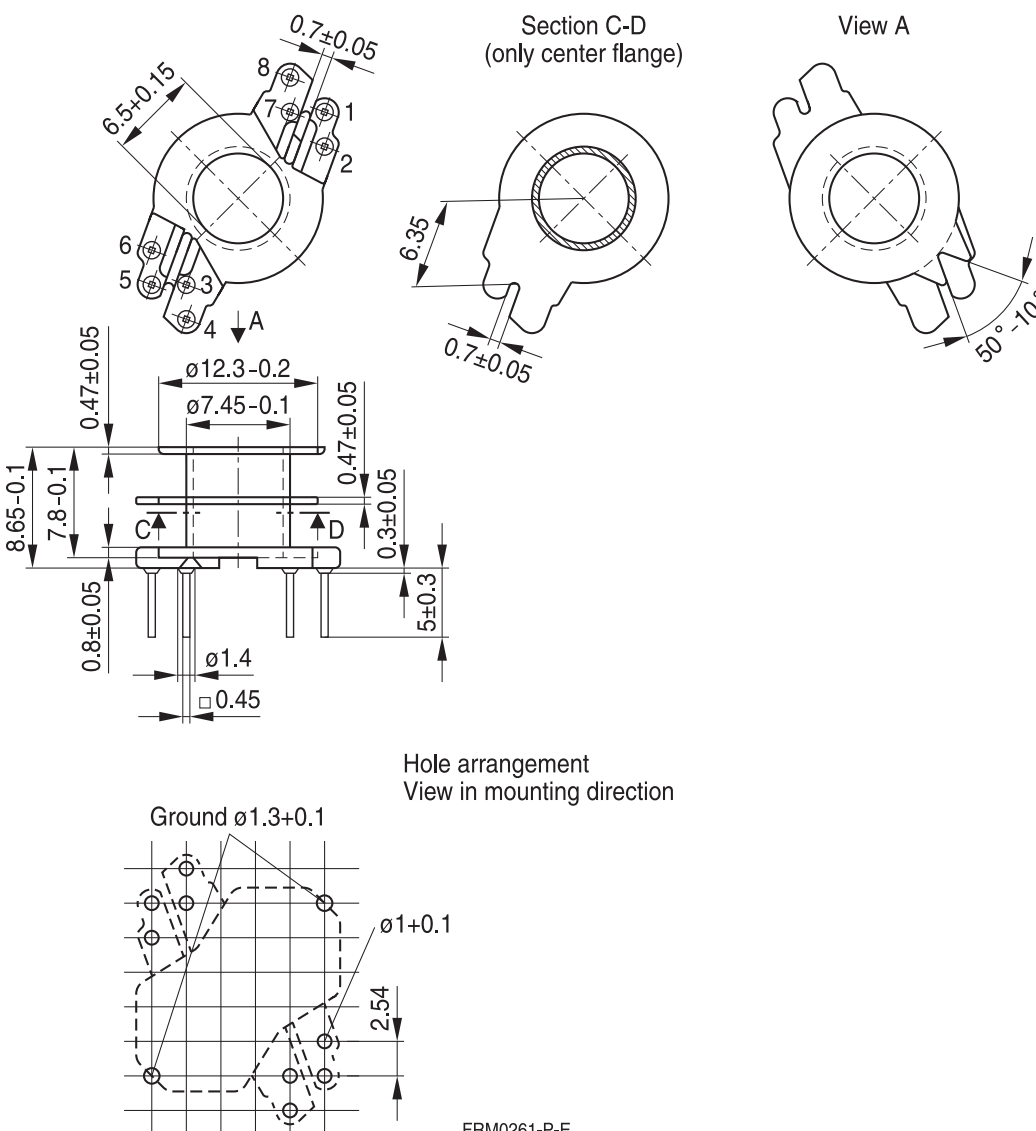
Solderability: to IEC 60068-2-20, test Ta, method 1 (aging 3): 235 °C, 2 s

Resistance to soldering heat: to IEC 60068-2-20, test Tb, method 1B: 350 °C, 3.5 s

Winding: see Processing notes, 2.1

For matching clamp and insulating washers see page 8.

| Sections | A_N mm ² | l_N mm | A_R value $\mu\Omega$ | Pins | Ordering code |
|----------|--------------------------|-------------|----------------------------|------|-----------------|
| 2 | 14 | 30 | 73 | 8 | B65808N1108D002 |



Coil former for power applications with angled pins

Optimized for automatic winding

Material: GFR polyterephthalate (UL 94 V-0, insulation class to IEC 60085:

 $F \triangleq$ max. operating temperature 155 °C), color code black

Valox 420-SE0 [E45329 (M)] SABIC INNOVATIVE PLASTICS B V

Solderability: to IEC 60068-2-20, test Ta, method 1 (aging 3): 235 °C, 2 s

Resistance to soldering heat: to IEC 60068-2-20, test Tb, method 1B: 350 °C, 3.5 s

Winding: see Processing notes, 2.1

For matching clamp and insulating washer 1 see page 8.

| Sections | A_N mm ² | l_N mm | A_R value $\mu\Omega$ | Pins | Ordering code |
|----------|--------------------------|-------------|----------------------------|------|-----------------|
| 1 | 15 | 30 | 69 | 8 | B65808E1508T001 |



Clamp

- With ground terminal, made of stainless spring steel (tinned), 0.4 mm thick
- Solderability to IEC 60068-2-20, test Ta, method 1 (aging 3): 235 °C, 2 s

Insulating washer 1 between core and coil former

- For tolerance compensation and for insulation
- Made of polyarylate film (UL 94 V-0, insulation class to IEC 60085: E \geq 120 °C), 0.08 mm thick Aryphan F685, [E167358 (M)], natural color, LOFO HIGH TECH FILM GMBH

Insulating washer 2 for double-clad PCBs

- Made of polycarbonate (UL 94 V-0, insulation class to IEC 60085: E \geq 120 °C), 0.25 mm thick Makrofol FR7-2 [E168120 (M)], COVESTRO AG

| | Ordering code |
|---|-----------------|
| Clamp (ordering code per piece, 2 are required) | B65808B2203X000 |
| Insulating washer 1 (reel packing, PU = 1 reel) | B65808A5000X000 |
| Insulating washer 2 (bulk) | B65808C2005X000 |

Clamp
Insulating washer 1
Insulating washer 2

Clamping forces for RM 6


F_{min} : Extension of clamp from a to $a_2 = X_{min}$
 F_{max} : Extension of clamp from a to $a_1 = X_{max}$

| | | |
|------------------------------|-----------|------|
| Clamp opening a (mm) | 9.5 +0.2 | |
| Core nose Z_{max} (mm) | 0.22 | |
| Height of core pair X (mm) | X_{min} | 10.1 |
| | X_{max} | 10.6 |
| Clamping force F (N) | F_{min} | 7 |
| | F_{max} | 50 |


SMD coil former with gullwing terminals

Material: GFR liquid crystal polymer (UL 94 V-0, insulation class to IEC 60085:
 $F \triangleq$ max. operating temperature 155 °C), color code black
 Vectra E 130i [E106764 (M)], POLYPLASTICS CO LTD
 Vectra E 130i [E83005 (M)], CELANESE INTERNATIONAL CORP.

Solderability: to IEC 60068-2-58, test Td, method 6 (Group 3): 245 °C, 3 s

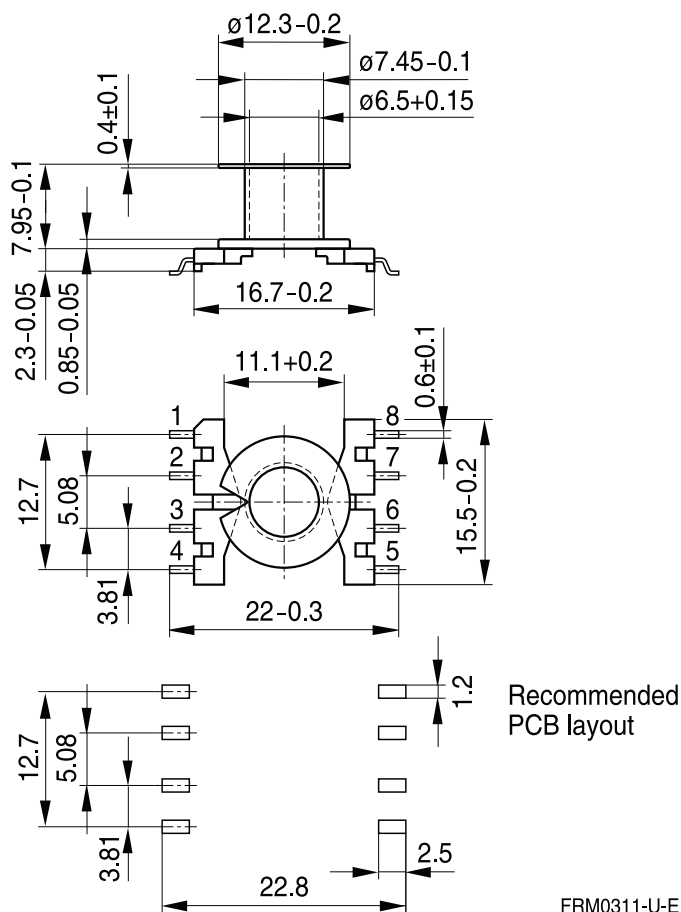
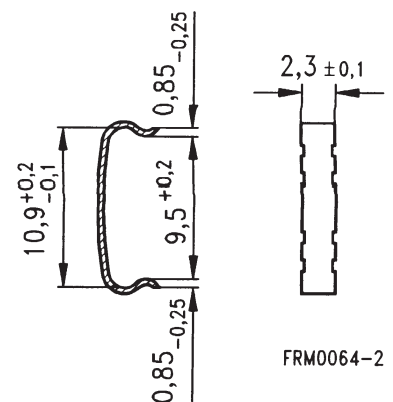
Resistance to soldering heat: to IEC 60068-2-58, test Td, method 6 (Group 3): 255 °C, 10 s
 permissible soldering temperature for wire-wrap connection on coil former: 400 °C, 1 s

Winding: see Processing notes, 2.1

Clamp

- Without ground terminal, made of stainless spring steel, 0.435 mm thick

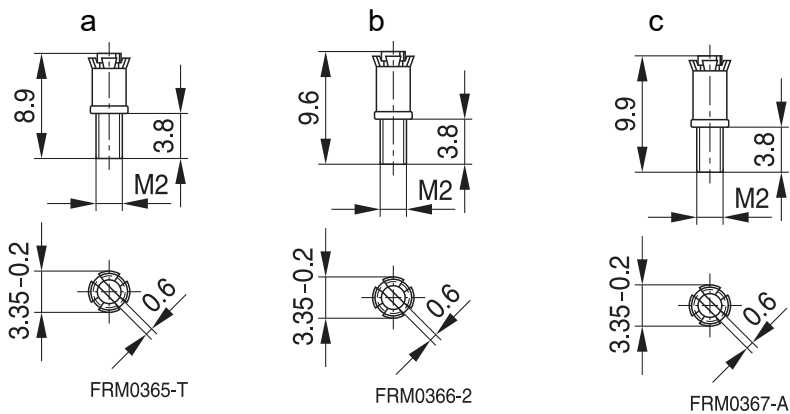
| Sections | A_N mm ² | l_N mm | A_R value $\mu\Omega$ | Terminals | Ordering code |
|--|--------------------------|-------------|----------------------------|-----------|-----------------|
| 1 | 16.2 | 31 | 66 | 8 | B65821C1008T001 |
| Clamp(ordering code per piece, 2 are required) | | | | | B65808J2204X000 |

Coil former

Clamp


Adjusting screw

- Tube core with thread and core brake made of GFR polyterephthalate
Pocan B3235® [E245249 (M)], LANXESS AG

| Figure | Tube core ∅ × length (mm) | Material | Color code | Ordering code |
|--------|------------------------------|----------|------------|-----------------|
| a | 2.62 × 3.6 | N22 | red | B65659F0001X023 |
| b | 2.75 × 4.4 | N22 | black | B65659F0003X023 |
| c | 2.82 × 4.4 | N22 | yellow | B65659F0004X023 |



RM 6 »Low Profile«
Core
B65807P

- To IEC 62317-4
- For compact transformers
- Without center hole
- Delivery mode: sets

Magnetic characteristics (per set)

$$\Sigma l/A = 0.58 \text{ mm}^{-1}$$

$$l_e = 21.8 \text{ mm}$$

$$A_e = 37.5 \text{ mm}^2$$

$$A_{\min} = 31.2 \text{ mm}^2$$

$$V_e = 820 \text{ mm}^3$$

Approx. weight 4.0 g/set


FRM0349-C

Ungapped

| Material | A_L value nH | μ_e | P_V W/set | Ordering code |
|----------|-------------------|---------|----------------------------------|-----------------|
| T38 | 10500 +40/-30% | 4860 | | B65807P0000Y038 |
| N49 | 2200 +30/-20% | 1020 | < 0.14 (50 mT, 500 kHz, 100 °C) | B65807P0000R049 |
| N92 | 2300 +30/-20% | 1060 | < 0.44 (200 mT, 100 kHz, 100 °C) | B65807P0000R092 |
| N87 | 3000 +30/-20% | 1390 | < 0.40 (200 mT, 100 kHz, 100 °C) | B65807P0000R087 |

 Other A_L values/air gaps and materials available on request – see Processing remarks on page 12.

Ferrites and accessories

Cautions and warnings

Mechanical stress and mounting

Ferrite cores have to meet mechanical requirements during assembling and for a growing number of applications. Since ferrites are ceramic materials one has to be aware of the special behavior under mechanical load.

As valid for any ceramic material, ferrite cores are brittle and sensitive to any shock, fast temperature changing or tensile load. Especially high cooling rates under ultrasonic cleaning and high static or cyclic loads can cause cracks or failure of the ferrite cores.

For detailed information see data book, chapter “*General - Definitions, 8.1*”.

Effects of core combination on A_L value

Stresses in the core affect not only the mechanical but also the magnetic properties. It is apparent that the initial permeability is dependent on the stress state of the core. The higher the stresses are in the core, the lower is the value for the initial permeability. Thus the embedding medium should have the greatest possible elasticity.

For detailed information see data book, chapter “*General - Definitions, 8.1*”.

Heating up

Ferrites can run hot during operation at higher flux densities and higher frequencies.

NiZn-materials

The magnetic properties of NiZn-materials can change irreversible in high magnetic fields.

Ferrite Accessories

EPCOS ferrite accessories have been designed and evaluated only in combination with EPCOS ferrite cores. EPCOS explicitly points out that EPCOS ferrite accessories or EPCOS ferrite cores may not be compatible with those of other manufacturers. Any such combination requires prior testing by the customer and will be at the customer's own risk.

EPCOS assumes no warranty or reliability for the combination of EPCOS ferrite accessories with cores and other accessories from any other manufacturer.

Processing remarks

The start of the winding process should be soft. Else the flanges may be destroyed.

- Too strong winding forces may blast the flanges or squeeze the tube that the cores can not be mounted any more.
- Too long soldering time at high temperature (>300 °C) may effect coplanarity or pin arrangement.
- Not following the processing notes for soldering of the J-leg terminals may cause solderability problems at the transformer because of pollution with Sn oxyde of the tin bath or burned insulation of the wire. For detailed information see chapter “*Processing notes*”, section 2.2.
- The dimensions of the hole arrangement have fixed values and should be understood as a recommendation for drilling the printed circuit board. For dimensioning the pins, the group of holes can only be seen under certain conditions, as they fit into the given hole arrangement. To avoid problems when mounting the transformer, the manufacturing tolerances for positioning the customers' drilling process must be considered by increasing the hole diameter.

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Ferrites and accessories

Symbols and terms

| Symbol | Meaning | Unit |
|---------------------|---|------------------------------|
| A | Cross section of coil | mm ² |
| A _e | Effective magnetic cross section | mm ² |
| A _L | Inductance factor; $A_L = L/N^2$ | nH |
| A _{L1} | Minimum inductance at defined high saturation ($\hat{=} \mu_a$) | nH |
| A _{min} | Minimum core cross section | mm ² |
| A _N | Winding cross section | mm ² |
| A _R | Resistance factor; $A_R = R_{Cu}/N^2$ | $\mu\Omega = 10^{-6} \Omega$ |
| B | RMS value of magnetic flux density | Vs/m ² , mT |
| ΔB | Flux density deviation | Vs/m ² , mT |
| \hat{B} | Peak value of magnetic flux density | Vs/m ² , mT |
| $\Delta \hat{B}$ | Peak value of flux density deviation | Vs/m ² , mT |
| B _{DC} | DC magnetic flux density | Vs/m ² , mT |
| B _R | Remanent flux density | Vs/m ² , mT |
| B _S | Saturation magnetization | Vs/m ² , mT |
| C ₀ | Winding capacitance | F = As/V |
| CDF | Core distortion factor | mm ^{-4.5} |
| DF | Relative disaccommodation coefficient $DF = d/\mu_i$ | |
| d | Disaccommodation coefficient | |
| E _a | Activation energy | J |
| f | Frequency | s ⁻¹ , Hz |
| f _{cutoff} | Cut-off frequency | s ⁻¹ , Hz |
| f _{max} | Upper frequency limit | s ⁻¹ , Hz |
| f _{min} | Lower frequency limit | s ⁻¹ , Hz |
| f _r | Resonance frequency | s ⁻¹ , Hz |
| f _{Cu} | Copper filling factor | |
| g | Air gap | mm |
| H | RMS value of magnetic field strength | A/m |
| \hat{H} | Peak value of magnetic field strength | A/m |
| H _{DC} | DC field strength | A/m |
| H _c | Coercive field strength | A/m |
| h | Hysteresis coefficient of material | 10 ⁻⁶ cm/A |
| h/μ_i^2 | Relative hysteresis coefficient | 10 ⁻⁶ cm/A |
| I | RMS value of current | A |
| I _{DC} | Direct current | A |
| \hat{I} | Peak value of current | A |
| J | Polarization | Vs/m ² |
| k | Boltzmann constant | J/K |
| k ₃ | Third harmonic distortion | |
| k _{3c} | Circuit third harmonic distortion | |
| L | Inductance | H = Vs/A |

Ferrites and accessories
Symbols and terms

| Symbol | Meaning | Unit |
|---------------------|--|--------------------|
| $\Delta L/L$ | Relative inductance change | H |
| L_0 | Inductance of coil without core | H |
| L_H | Main inductance | H |
| L_p | Parallel inductance | H |
| L_{rev} | Reversible inductance | H |
| L_s | Series inductance | H |
| l_e | Effective magnetic path length | mm |
| l_N | Average length of turn | mm |
| N | Number of turns | |
| P_{Cu} | Copper (winding) losses | W |
| P_{trans} | Transferrable power | W |
| P_V | Relative core losses | mW/g |
| PF | Performance factor | |
| Q | Quality factor ($Q = \omega L/R_s = 1/\tan \delta_L$) | |
| R | Resistance | Ω |
| R_{Cu} | Copper (winding) resistance ($f = 0$) | Ω |
| R_h | Hysteresis loss resistance of a core | Ω |
| ΔR_h | R_h change | Ω |
| R_i | Internal resistance | Ω |
| R_p | Parallel loss resistance of a core | Ω |
| R_s | Series loss resistance of a core | Ω |
| R_{th} | Thermal resistance | K/W |
| R_V | Effective loss resistance of a core | Ω |
| s | Total air gap | mm |
| T | Temperature | $^{\circ}\text{C}$ |
| ΔT | Temperature difference | K |
| T_C | Curie temperature | $^{\circ}\text{C}$ |
| t | Time | s |
| t_v | Pulse duty factor | |
| $\tan \delta$ | Loss factor | |
| $\tan \delta_L$ | Loss factor of coil | |
| $\tan \delta_r$ | (Residual) loss factor at $H \rightarrow 0$ | |
| $\tan \delta_e$ | Relative loss factor | |
| $\tan \delta_h$ | Hysteresis loss factor | |
| $\tan \delta/\mu_i$ | Relative loss factor of material at $H \rightarrow 0$ | |
| U | RMS value of voltage | V |
| \hat{U} | Peak value of voltage | V |
| V_e | Effective magnetic volume | mm^3 |
| Z | Complex impedance | Ω |
| Z_n | Normalized impedance $ Z _n = Z /N^2 \times \epsilon (l_e/A_e)$ | Ω/mm |

Ferrites and accessories

Symbols and terms

| Symbol | Meaning | Unit |
|--------------|--|-----------------------------------|
| α | Temperature coefficient (TK) | 1/K |
| α_F | Relative temperature coefficient of material | 1/K |
| α_e | Temperature coefficient of effective permeability | 1/K |
| ϵ_r | Relative permittivity | |
| Φ | Magnetic flux | Vs |
| η | Efficiency of a transformer | |
| η_B | Hysteresis material constant | mT ⁻¹ |
| η_i | Hysteresis core constant | A ⁻¹ H ^{-1/2} |
| λ_s | Magnetostriction at saturation magnetization | |
| μ | Relative complex permeability | |
| μ_0 | Magnetic field constant | Vs/Am |
| μ_a | Relative amplitude permeability | |
| μ_{app} | Relative apparent permeability | |
| μ_e | Relative effective permeability | |
| μ_i | Relative initial permeability | |
| μ_p' | Relative real (inductive) component of $\bar{\mu}$ (for parallel components) | |
| μ_p'' | Relative imaginary (loss) component of $\bar{\mu}$ (for parallel components) | |
| μ_r | Relative permeability | |
| μ_{rev} | Relative reversible permeability | |
| μ_s' | Relative real (inductive) component of $\bar{\mu}$ (for series components) | |
| μ_s'' | Relative imaginary (loss) component of $\bar{\mu}$ (for series components) | |
| μ_{tot} | Relative total permeability derived from the static magnetization curve | |
| ρ | Resistivity | Ωm^{-1} |
| $\Sigma l/A$ | Magnetic form factor | mm^{-1} |
| τ_{Cu} | DC time constant $\tau_{Cu} = L/R_{Cu} = A_L/A_R$ | s |
| ω | Angular frequency; $\omega = 2 \Pi f$ | s ⁻¹ |

All dimensions are given in mm.

SMD Surface-mount device

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[B65808S1108D002](#) [B65808C2005X000](#) [B65807J0000R087](#) [B65807J0100A033](#)

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9